## NTAG203F

# NFC Forum Type 2 Tag compliant IC with 144 bytes user memory and field detection

Rev. 3.3 — 12 February 2013 220632

Product data sheet COMPANY PUBLIC

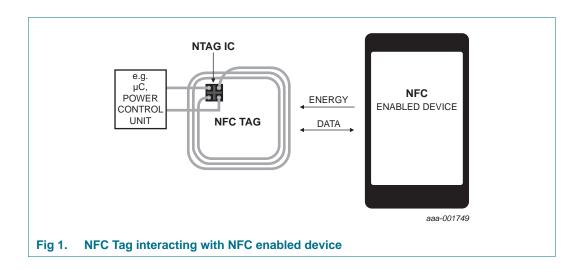
### 1. General description

NXP Semiconductors has developed NTAG203F - NFC Forum Type 2 Tag compliant IC - to be used with NFC enabled devices according to NFC Forum technical specifications (see Ref. 8 and Ref. 9), according to NFC Forum recommendations or Proximity Coupling Devices (PCD), according to ISO/IEC 14443A (see Ref. 1). The communication layer (RF Interface) complies to parts 2 and 3 of the ISO/IEC 14443A standard. The NTAG203F is primarily designed for NFC Forum Type 2 Tag applications in electronics (i.e. connection handover, Bluetooth simple pairing, Wi-Fi Protected set-up, device authentication, gaming and others).

#### 1.1 Contactless energy and data transfer

Communication to NTAG can be established only when the IC is connected to an antenna. Form and specification of the coil is out of scope of this document. For details on how to design antennas see Ref. 6.

When the NTAG is positioned in the RF field, the high speed RF communication interface allows the transmission of the data with a baud rate of 106 kbit/s.





#### NFC Forum compliant IC with user memory and field detection

#### 1.2 Naming conventions

Table 1. Short naming convention (for easier product identification)

Family name	Description
NTAG	NXP NFC Tag product family name
2	Platform indicator
0	Generation number (starting from 0)
3	Code number for size (0 : < 64 bytes, 1 : 64-96 bytes; 2 : 96-128 bytes; 3 : 128-256 bytes)
F	HWSON8 and HXSON4 package with Field Detection pin

#### 2. Features and benefits

#### 2.1 RF Interface (ISO/IEC 14443A)

- Contactless transmission of data and supply energy (no battery needed)
- Operating distance: up to 100 mm (depending on various parameters as e.g. field strength and antenna geometry)
- Operating frequency: 13.56 MHz
- Fast data transfer: 106 kbit/s
- High data integrity: 16-bit CRC, parity, bit coding, bit counting
- True anticollision
- 7 byte serial number (cascade level 2 according to ISO/IEC 14443-3)

#### 2.2 EEPROM

- 168 bytes of total memory, divided in 42 pages (4 bytes each)
- 144 bytes of user r/w memory area, divided in 36 pages (4 bytes each)
- Field programmable read-only locking function per page 16 pages (64 bytes) of the memory
- Field programmable read-only locking function per block (2 pages)
- 32-bit user definable One-Time Programmable (OTP) area
- 16-bit counter
- Data retention of 10 years
- Write endurance 10000 cycles

#### 2.3 NFC Forum Tag 2 Type compliance

NTAG203F IC provides full compliance to the NFC Forum Tag 2 Type technical specification (see Ref. 8) and enables NDEF data structure configurations (see Ref. 9).

#### 2.4 Field detection

NTAG203F features an additional RF field detection functionality. The corresponding output signal can be used as interrupt source to e.g. wake up an embedded microcontroller or trigger further actions. Typical applications are Bluetooth and Wi-Fi pairing.

#### NFC Forum compliant IC with user memory and field detection

For detailed information refer to Application note Ref. 11 "AN11141 How to use the FD pin".

#### 2.5 Security

- Anti-cloning support by unique 7-byte serial number for each device
- 32-bit one way counter
- Field programmable read-only locking function per page for first 16 pages (64 bytes) of the memory
- Read-only locking per block for rest of memory

#### 2.6 Cascaded UID

The anticollision function is based on an IC individual serial number called Unique IDentifier. The UID of the NTAG203F is 7 bytes long and supports cascade level 2 according to ISO/IEC 14443-3.

#### 2.7 Anticollision

An intelligent anticollision function according to ISO/IEC 14443 allows to operate more than one tag in the field simultaneously. The anticollision algorithm selects each tag individually and ensures that the execution of a transaction with a selected tag is performed correctly without data corruption resulting from other tags in the field.

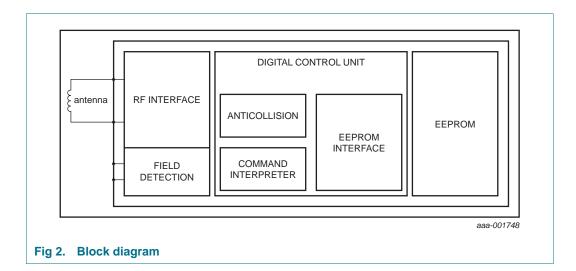
### 3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
NT2H0301F0DTP	HWSON8	plastic leadless module carrier package; 35 mm wide tape	-
NT2H0301F0DTL	HXSON4	plastic leadless module carrier package; 35 mm wide tape	-

#### NFC Forum compliant IC with user memory and field detection

### 4. Block diagram



### 5. Pinning information

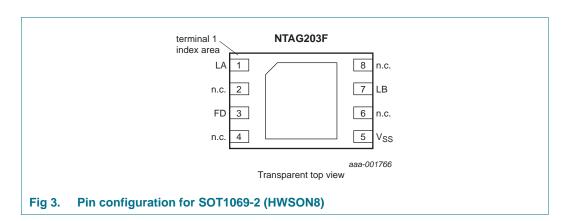


Table 3. Pin description of the HWSON8 package

Contactless interface module		NTAG203F
Antenna contacts	Symbol	Description
Pin 1	LA	Antenna connection LA
Pin 2	n.c.	not connected
Pin 3	FD	RF Field Detect connection
Pin 4	n.c.	not connected
Pin 5	V <sub>SS</sub>	GND connection
Pin 6	n.c.	not connected
Pin 7	LB	Antenna connection LB
Pin 8	n.c.	not connected

#### NFC Forum compliant IC with user memory and field detection

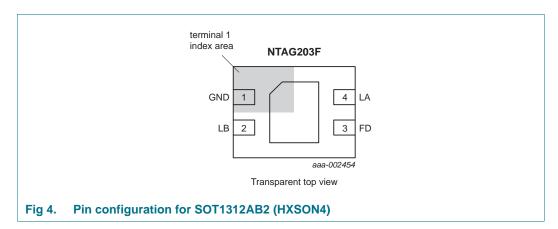


Table 4. Pin description of the HXSON4 package

	•	
Contactless interface module		NTAG203F
Antenna contacts	Symbol	Description
Pin 1	GND	Ground
Pin 2	LB	Antenna connection LB
Pin 3	FD	RF Field Detect connection
Pin 4	LA	Antenna connection LA

### 6. Marking

#### 6.1 Marking HWSON8

Table 5. Marking HWSON8 (NTAG203F)

Type number	Description	
NT2H0301F0DTP	Marking Line A	N1F
	Marking Line B	batch code
	Marking Line C	nDy
	Marking Line C	ww

### 6.2 Marking HXSON4

Table 6. Marking HXSON4 (NTAG203F)

Type number	Description	
NT2H0301F0DTL	Marking Line A	N1F
	Marking Line B	yww

#### NFC Forum compliant IC with user memory and field detection

### 7. Functional description

#### 7.1 Block description

The NTAG203F chip consists of the 168 bytes of the total EEPROM memory organized in 42 pages each 4 bytes. 144 bytes (36 pages) are available for the user defined data.

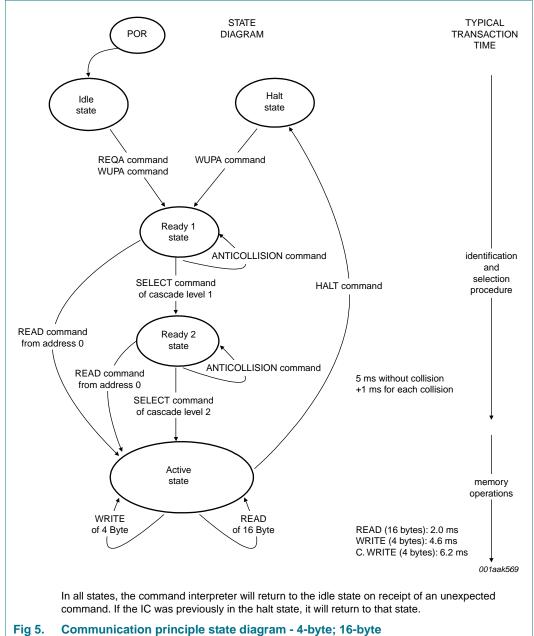
Along with the memory, NTAG203F contains the RF-Interface and the Digital Control Unit. Energy and data are transferred via an antenna, which consists of a coil with a few turns directly connected to the LA and LB of the NTAG203F (see Section 5 for details). No further external components are necessary. (For details on antenna design please refer to the document Ref. 6 "AN11276 NTAG Antenna Design Guide".)

NTAG203F **NXP Semiconductors** 

#### NFC Forum compliant IC with user memory and field detection

### 7.2 State diagram and logical states description

Commands are initiated by the NFC device and controlled by the NTAG203F command interpreter. This processes the internal states and generates the appropriate response.



#### NFC Forum compliant IC with user memory and field detection

#### 7.2.1 Idle state

After a Power-On Reset (POR), the NTAG203F switches directly to the idle state. It only exits this state when a REQA or a WUPA command is received from the NFC device. Any other data received while in the idle state is interpreted as an error and the NTAG203F remains Idle.

After a correctly executed HALT command, the halt state changes to the wait state which can be exited with a WUPA command.

#### 7.2.2 Ready1 state

In this state, the NTAG203F supports the NFC device when resolving the first part of its UID (3 bytes) with the ANTICOLLISION or SELECT command from cascade level 1. This state is exited correctly after execution of either of the following commands:

- SELECT command from cascade level 1: the NFC device switches NTAG203F into Ready2 state where the second part of the UID is resolved.
- READ command (from address 0): all anticollision mechanisms are bypassed and NTAG203F switches directly to the active state.

**Remark:** If more than one NTAG203F is in the NFC device field, a READ command from address 0 causes a collision due to the different serial numbers and all NTAG203F devices are selected. Any other data received in the Ready1 state is interpreted as an error and depending on its previous state the NTAG203F returns to the wait, idle or halt state.

#### 7.2.3 Ready2 state

In this state, the NTAG203F supports the NFC device when resolving the second part of its UID (4 bytes) with the cascade level 2 ANTICOLLISION command. This state is usually exited using the cascade level 2 SELECT command.

Alternatively, state Ready2 may be skipped using a READ command (from address 0) as described in state Ready1.

Remark: If more than one NTAG203F is in the NFC device field, a READ command from address 0 causes a collision due to the different serial numbers and all NTAG203F devices are selected. The response of the NTAG203F to the cascade level 2 SELECT command is the Select Acknowledge (SAK) byte. In accordance with ISO/IEC 14443 this byte indicates if the anticollision cascade procedure has finished. The NTAG203F is now uniquely selected and only this device will communicate with the NFC device even when other contactless devices are present in the NFC device field. Any other data received when the device is in this state is interpreted as an error and depending on its previous state the NTAG203F returns to the wait, idle or halt state.

#### 7.2.4 Active state

In the active state either a 16-byte READ or 4-byte WRITE command can be performed. The HALT command exits either the READ or WRITE commands in their active state. Any other data received when the device is in this state is interpreted as an error and depending on its previous state the NTAG203F returns to the wait, idle or halt state.

#### NFC Forum compliant IC with user memory and field detection

#### 7.2.5 Halt state

The halt and idle states constitute the second wait state implemented in the NTAG203F. An already processed NTAG203F can be set into the halt state using the HALT command. In the anticollision phase, this state helps the NFC device to distinguish between processed tags and tags yet to be selected. The NTAG203F can only exit this state on execution of the WUPA command. Any other data received when the device is in this state is interpreted as an error and the NTAG203F state is unchanged. Refer to the document MIFARE collection of currently available application notes for correct implementation of an anticollision procedure based on the idle and halt states and the REQA and WUPA commands.

#### 7.3 Data integrity

The following mechanisms are implemented in the contactless communication link between NFC device and NTAG203F to ensure a reliable data transmission:

- 16 bits CRC per block
- Parity bit for each byte
- Bit count checking
- Bit coding to distinguish between "1", "0", and no information
- Channel monitoring (protocol sequence and bit stream analysis)

#### 7.4 RF interface

The RF-interface is according to the standard for contactless smart cards ISO/IEC 14443A (see Ref. 1).

The RF-field from the NFC device is always present (with short modulation pulses when transmitting data), because it is used for the power supply of the tag.

For both directions of data communication there is one start bit at the beginning of each frame. Each byte is transmitted with a parity bit (odd parity) at the end. The LS Bit of the byte with the lowest address of the selected block is transmitted first. The maximum frame length is 164 bits (16 data bytes + 2 CRC bytes = 16 \* 9 + 2 \* 9 + 1 start bit + 1 end bit).

#### NFC Forum compliant IC with user memory and field detection

#### 7.5 Memory organization

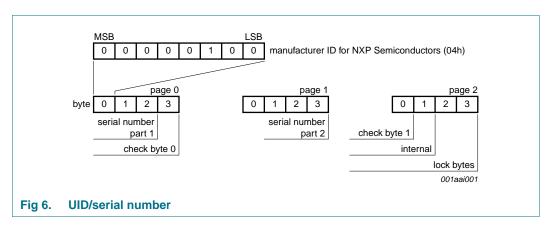
The 168 bytes of the total EEPROM memory are organized in 42 pages each 4 bytes. 144 bytes (36 pages) are available for the user defined data. Each page contains 4 bytes (32 bits).

Table 7. Memory organization

Page address		Byte number				
Decimal	Hex	0 1 2 3				
0	00h	serial number				
1	01h	serial number				
2	02h	serial number internal		Lock byte 0	Lock byte 1	
3	03h	Capability Conta	ainer (CC)			
4 to 39	04h to 27h	user memory	user memory	user memory	user memory	
40	28h	Lock byte 2 Lock byte 3		-	-	
41	29h	16-bit counter				

#### 7.5.1 UID/serial number

The unique 7 byte serial number (UID) and its two Block Check Character Bytes (BCC) are programmed into the first 9 bytes of the memory. It therefore covers page 00h, page 01h and the first byte of page 02h. The second byte of page 02h is reserved for internal data. Due to security and system requirements these bytes are write-protected after the programming during the IC production.



According to ISO/IEC 14443-3 BCC0 is defined as CT  $\oplus$  SN0  $\oplus$  SN1  $\oplus$  SN2. Abbreviations CT stays for Cascade Tag byte (88h) and BCC1 is defined as SN3  $\oplus$  SN4  $\oplus$  SN5  $\oplus$  SN6.

SN0 holds the Manufacturer ID for NXP (04h) according to ISO/IEC 14443-3 and ISO/IEC 7816-6 AMD.1.

#### NFC Forum compliant IC with user memory and field detection

#### 7.5.2 Lock bytes

Lock bytes enable the user to lock parts of the complete memory area for writing. A Read from user memory area cannot be restricted via lock bytes functionality.

The lock bytes functionality is enabled with a WRITE command (see Section 7.9.7 "WRITE") or COMPATIBILITY WRITE command (see Section 7.9.8 "COMPATIBILITY WRITE"), where 2 out of 4 bytes transmitted are used for setting the lock bytes. Two corresponding bytes - either bytes 2 and 3 for page 02h or bytes 0 and 1 for page 28h - and the actual content of the lock bytes are bit-wise "OR-ed". The result of OR operation becomes the new content of the lock bytes. Two unused bytes do not have to be considered. Although included in the COMPATIBILITY WRITE or WRITE command, they are ignored when programming the memory.

Table 8. Lock bytes

Name	Page		Function
	Number	Address	
Lock byte 0	2	02h	page and block locking
Lock byte 1	2	02h	page locking
Lock byte 2	40	28h	page and block locking
Lock byte 3	40	28h	functionality and block locking

Due to the built-in bitwise OR operation, this process is irreversible. If a bit is set to "1", it cannot be changed back to "0" again. Therefore, before locking the lock bytes, the user must ensure that the corresponding user memory area and/or configuration bytes are correctly written.

The configuration written in the lock bytes is active upon the next REQA or WUPA command.

The single bits of the 4 bytes available for locking incorporate 3 different functions:

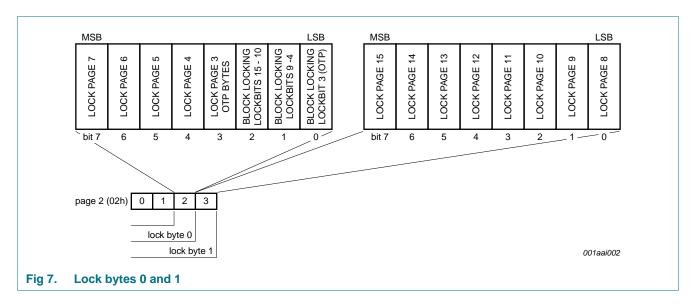
- the read-only locking of the single pages or blocks of the user memory area
- the read-only locking of the single bytes of the configuration memory area
- · the locking of the lock bits themselves

The mapping of single bits to memory area for the first 64 bytes (512 bits) is shown in Figure 7.

The bits of byte 2 and 3 of page 02h represent the field-programmable read-only locking mechanism. Each page from 03h (OTP bits) to 0Fh may be locked individually to prevent further write access by setting the corresponding locking bit Lx to 1. After locking the page is read-only memory.

The 3 least significant bits of lock byte 0 of page 2 are the block-locking bits. Bit 2 handles pages 0Fh to 0Ah, bit 1 pages 09h to 04h and bit 0 page 03h (OTP bits). Once the block locking bits are set, the locking configuration for the corresponding memory area is frozen.

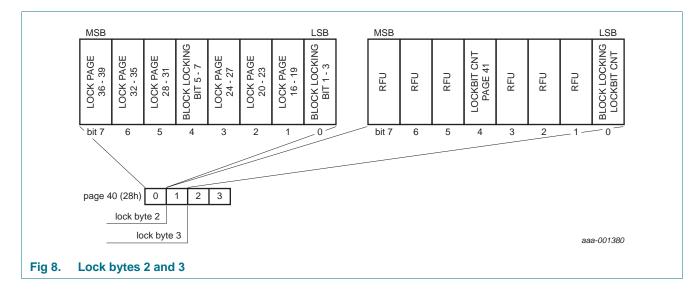
#### NFC Forum compliant IC with user memory and field detection



For locking of pages starting at page address 10h onwards, lock bytes located in page 28h are used. Those two lock bytes cover the memory area of 96 data bytes together with configuration area from page address 28h onwards. Therefore, the granularity is larger then for the first 64 bytes as shown in Figure 8 "Lock bytes 2 and 3".

The functionality beyond page address 28h which can be locked read-only is:

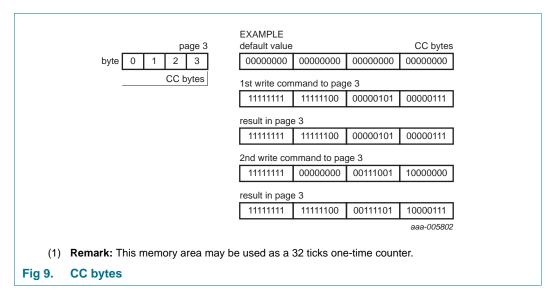
- the counter
- · the lock bytes themselves



#### NFC Forum compliant IC with user memory and field detection

#### 7.5.3 Capability Container (CC)

The Capability Container CC (page 3) is programmed during the IC production according to the NFC Forum Type 2 Tag specification Ref. 8. These bytes may be bit-wise modified by a WRITE command.



The bytes of the WRITE command and the current contents of the CC bytes are bit-wise "OR-ed" and the result becomes the new content of the CC bytes. This process is irreversible. If a bit is set to "1", it cannot be changed back to "0" again.

#### 7.5.4 Data pages

NTAG203F features 144 bytes of data memory. The address range from page 04h to 27h constitutes the read/write area.

Initial state of each byte in the user area is 00h.

A write access to data memory is achieved with WRITE (see <a href="Section 7.9.7" WRITE">Section 7.9.7 "WRITE"</a>) or COMPATIBILITY WRITE (see <a href="Section 7.9.8" COMPATIBILITY WRITE">Section 7.9.8 "COMPATIBILITY WRITE"</a>) command. In both cases, 4 bytes of memory (one page) will be overwritten. Write access to data memory can be permanently restricted via lock bytes (see <a href="Section 7.5.2" Lock bytes">Section 7.5.2 "Lock bytes"</a>).

#### NFC Forum Type 2 Tag compliance

NTAG203F has been designed to be compliant with NFC Forum Type 2 Tag specification (see also Ref. 5 "AN1303 Ultralight as Type 2 Tag"). With its 144 bytes of data memory, it can easily support use cases like connection handover, Bluetooth simple pairing, Wi-Fi Protected set-up, device authentication, gaming and others.

#### NFC Forum compliant IC with user memory and field detection

#### 7.5.5 Initial memory configuration

The memory configuration of NTAG203F in delivery state is shown in <u>Table 9 "Initial</u> memory organization":

Table 9. Initial memory organization

Page address			Byte r	number	
dec.	hex.	0	1	2	3
0	00h	UID0	UID1	UID2	BCC0
1	01h	UID3	UID4	UID5	UID6
2	02h	BCC1	internal	00h	00h
3	03h	E1h	10h	12h	00h
4	04h	01h	03h	A0h	10h
5	05h	44h	03h	00h	FEh
6 to 39	06h to 27h	00h	00h	00h	00h
40	28h	00h	00h	rfu	rfu
41	29h	00h	00h	rfu	rfu

The memory configuration in pages 3 to 5 ensures that NTAG203F is a NFC forum Type 2 Tag in INITIALIZED state according to the NFC Forum Technical Specification, Ref. 8 "NFC Forum Tag 2 Type Operation, Technical Specification". It is recommended that any further modification of the memory pages 2 to 40 should be according to the Ref. 8 "NFC Forum Tag 2 Type Operation, Technical Specification".

All lock bytes are set to zero meaning that no page or functionality is locked. Counter is set to zero.

#### NFC Forum compliant IC with user memory and field detection

#### 7.6 Counter

NTAG203F features 16-bit one-way counter, located at first two bytes of page 29h. In its delivery state, counter value is set to 0000h.

The first¹ valid Write or Compatibility write to the address 29h can be performed with any value in the range between 0001h and FFFFh and corresponds to initial counter value. Every consequent valid WRITE command, which represents the increment, can contain values between 0001h and 000Fh. Upon such WRITE command and following mandatory RF reset, the value written to the address 29h is added to the counter content.

If - after initial write - a value higher than 000Fh is used as a parameter, NTAG203F will answer with NAK. Once counter value reaches FFFFh and an increment is performed via valid command, NTAG203F will answer with NAK. If the sum of counter value and increment is higher than FFFFh, NTAG203F will answer with NAK and will not update the counter.

Increment by zero (00h) is always possible, but does not have any impact to counter value.

#### 7.7 Tag response to a command from NFC device

NFC Tag Type 2 compliant IC uses, apart from the responses defined in the following sections, two half-byte answers to acknowledge the command received in Active state (see Figure 5 "Communication principle state diagram - 4-byte; 16-byte").

NFC Tag Type 2 compliant IC distinguishes between positive (ACK) and negative (NAK) acknowledge. Valid values for ACK and NAK are shown in <a href="Table 10">Table 10 "ACK and NAK values"</a>.

Table 10. ACK and NAK values

Answer value	Answer explanation	
Ah	positive acknowledge (ACK)	
1h	parity or CRC error (NAK)	
0h	any other error (NAK)	

After every NAK, NTAG203F will perform an internal reset.

#### 7.8 NFC Forum Device timings requirements

For all READ (<u>Section 7.9.5</u>) and WRITE (<u>Section 7.9.7</u>) timings for the NFC device see section 9 of the NFC Digital Protocol, Technical Specification, Version 1.0 (see Ref. 12).

NTAG203F

<sup>1.</sup> First valid write is defined as write to a counter value of zero with an argument different then zero

#### NFC Forum compliant IC with user memory and field detection

#### 7.9 Command set

The ATQA and SAK are identical as for MIFARE Ultralight (see Ref. 7 "MF0ICU1 Functional specification MIFARE Ultralight"). For information on ISO 14443 card activation, see Ref. 3 "AN10834 MIFARE ISO/IEC 14443 PICC Selection". Summary of data relevant for device identification is given in Section 7.10 "Summary of relevant data for device identification".

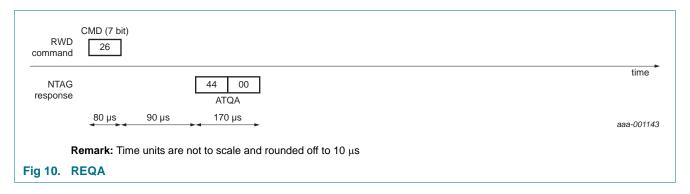
The NTAG203F comprises the command set as described in following chapters.

#### 7.9.1 **REQA**

Table 11. REQA

Code	Parameter	Data	Integrity mechanism	Response
26h (7-bit)	-	-	Parity	0044h

**Description:** The NTAG203F accepts the REQA command in Idle state only. The response is the 2-byte ATQA (0044h). REQA and ATQA are implemented fully according to ISO/IEC 14443-3.

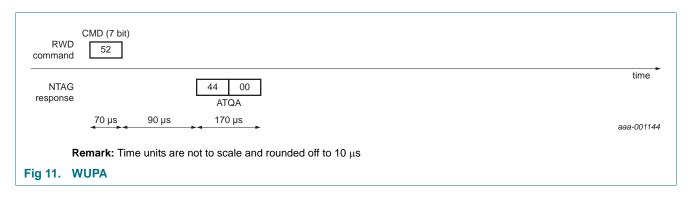


#### 7.9.2 WUPA

Table 12. WUPA

Code	Parameter	Data	Integrity mechanism	Response
52h (7-bit)	-	-	Parity	0044h

**Description:** NTAG203F accepts the WUPA command in the Idle and Halt state only. The response is the 2-byte ATQA (0044h). WUPA is implemented fully according to ISO/IEC 14443-3.



NTAG203F

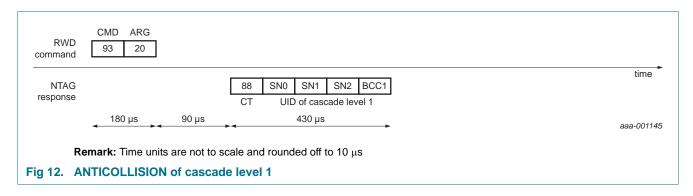
NFC Forum compliant IC with user memory and field detection

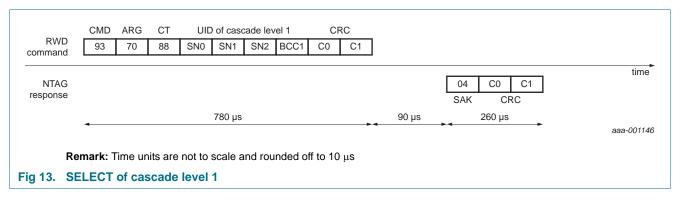
#### 7.9.3 ANTICOLLISION and SELECT of cascade level 1

Table 13. ANTICOLLISION and SELECT of cascade level 1

Code	Parameter	Data	Integrity mechanism	Response
Anticollision: 93h	20h	-	Parity, BCC	-
Anticollision: 93h	21h to 67h	Part of the UID	Parity, BCC	Parts of UID
Select: 93h	70h	First 3 bytes of UID	Parity, BCC, CRC	SAK ('04')

**Description:** The ANTICOLLISION and SELECT commands are based on the same command code. They differ only in the Parameter byte. This byte is per definition 70h in case of SELECT. NTAG203F accepts these commands in the Ready1 state only. The response is part 1 of the UID. Even with incorrect CRC value, the SELECT command will be fully functional.





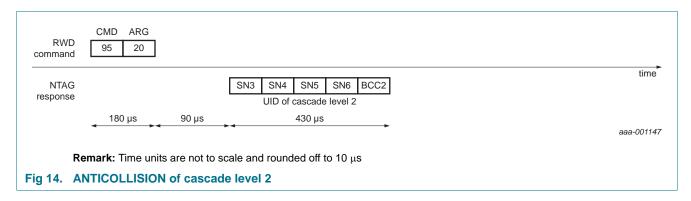
#### NFC Forum compliant IC with user memory and field detection

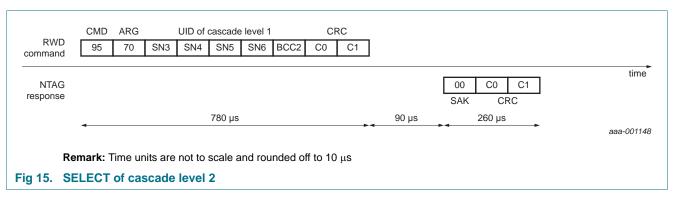
#### 7.9.4 ANTICOLLISION and SELECT of cascade level 2

Table 14. ANTICOLLISION and SELECT of cascade level 2

Code	Parameter	Data	Integrity mechanism	Response
Anticollision: 95h	20h	-	Parity, BCC	-
Anticollision: 95h	21h to 67h	Part of the UID	Parity, BCC	Parts of UID
Select: 95h	70h	Second 4 bytes of UID	Parity, BCC, CRC	SAK ('00')

**Description:** The ANTICOLLISION and SELECT commands are based on the same command code. They differ only in the parameter byte. This byte is per definition 70h in case of SELECT. NTAG203F accepts these commands in the Ready2 state only. The response is part 2 of the UID. Even with incorrect CRC value, the SELECT command will be fully functional.





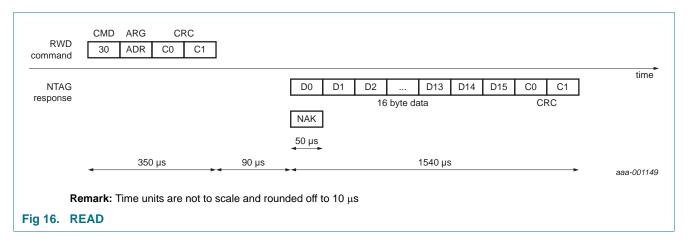
#### NFC Forum compliant IC with user memory and field detection

#### 7.9.5 **READ**

Table 15. READ

Code	Parameter/ARG	Data	Integrity mechanism	Response
30h	ADR: '00h' to '29h'	-	Parity, CRC	16 Byte Date

**Description:** The READ command needs the page address as a parameter. Only addresses 00h to 29h are decoded. For higher addresses, NTAG203F returns a NAK. The NTAG203F responds to the READ command by sending 16 bytes starting from the page address defined in the command (e.g. if ADR is '03h' pages 03h, 04h, 05h, 06h are returned. If ADR is '29h', the contents of pages 29h, 00h, 01h and 02h is returned).

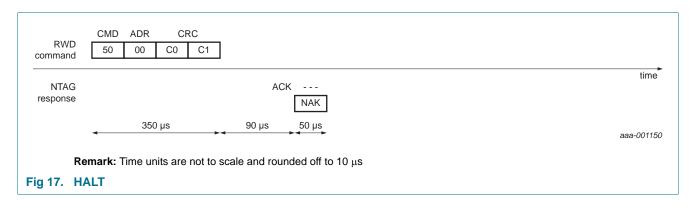


#### 7.9.6 HALT

Table 16. HALT

Code	Parameter	Data	Integrity mechanism	Response
50h	00h	-	Parity, CRC	Passive ACK, NAK

**Description:** The HALT command is used to set already processed NTAG203F devices into a different waiting state (Halt instead of Idle), which allows a simple separation between devices whose UIDs are already known (as they have already passed the anticollision procedure) and devices that have not yet been identified by their UIDs. This mechanism is a very efficient way of finding all contactless devices in the field of a NFC device. Even with incorrect parity value, the HALT command will be fully functional.



NTAG203F

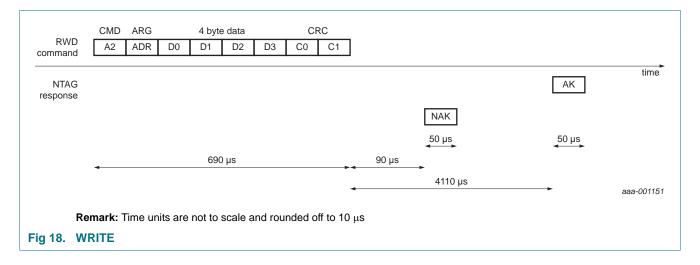
#### NFC Forum compliant IC with user memory and field detection

#### **7.9.7 WRITE**

Table 17. WRITE

Code	Parameter/ARG	Data	Integrity mechanism	Response
A2h	ADR: '02h' to '29h'	4 Byte	Parity, CRC	ACK or NAK

**Description:** The WRITE command is used to program the lock bytes in page 02h, the CC bytes in page 03h or the data bytes in pages 04h to 05h. A WRITE command is performed page-wise, programming 4 bytes in a page.



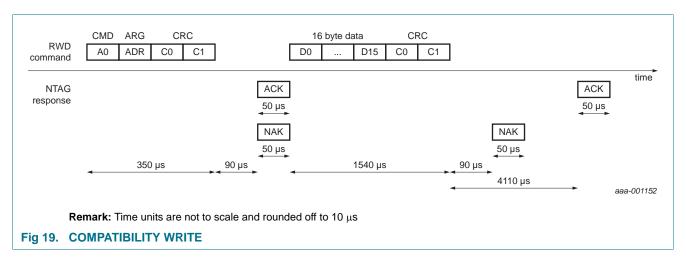
#### NFC Forum compliant IC with user memory and field detection

#### 7.9.8 COMPATIBILITY WRITE

Table 18. COMPATIBILITY WRITE

Code	Parameter/ARG	Data	Integrity mechanism	Response
A0h	ADR: '02h' to '29h'	16 Byte	Parity, CRC	ACK or NAK

**Description:** The COMPATIBILITY WRITE command was implemented to accommodate the established NFC device infrastructure. Even though 16 bytes are transferred to the NTAG203F, only the least significant 4 bytes (bytes D0 to D3) will be written to the specified address. It is recommended to set the remaining bytes D4 to D15 to all '0'.



**REMARK:** The timings in Fig.19 are typical timings. The NFC forum device must respect the following minimum timings and maximum timeouts.

Table 19. COMPATIBILITY\_WRITE timing

These times exclude the end of communication of the NFC Forum device.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
COMPATIBILITY_WRITE 1st ACK/NAK	71 μs	$T_{TimeOut}$	71 μs	$T_{TimeOut}$	5 ms
COMPATIBILITY_WRITE 2nd ACK/NAK	71 μs	$T_{TimeOut}$	71 μs	$T_{TimeOut}$	10 ms

#### NFC Forum compliant IC with user memory and field detection

### 7.10 Summary of relevant data for device identification

Table 20. Summary of relevant data for device identification

Code	Туре	Value	Binary Format	Remark
ATQA	2 Byte	0044h	0000 0000 0100 0100 1st '1' indicates cascade level 2 2 <sup>nd</sup> '1' indicates	ОК
CT	4 D. 44	006	family	Hand Cadad
СТ	1 Byte Cascade Tag	88h	1000 1000 ensures collision with cascade level 1 products	Hard Coded
SAK (casc. level 1)	1 Byte	04h	0000 0100 '1' indicates additional cascade level	ОК
SAK (casc. level 2)	1 Byte	00h	0000 0000 indicates complete UID and NTAG203F functionality	ОК
Manufacturer Byte	1 Byte	04h	0000 0100 indicates manufacturer NXP	Acc. to ISO/IEC 14443-3 and ISO/IEC 7816-6 AMD.1

#### NFC Forum compliant IC with user memory and field detection

### 8. Limiting values

Table 21. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1][2]

Symbol	Parameter	Conditions		Min	Max	Unit
I <sub>I</sub>	input current			-	30	mA
I <sub>load</sub>	load current	FD-V <sub>SS</sub>	[4]	-	10	μΑ
T <sub>stg</sub>	storage temperature			-55	+125	°C
T <sub>amb</sub>	ambient temperature			-25	+70	°C
V <sub>ESD</sub>	electrostatic discharge voltage	measured on pin LA-LB	[3]	2	-	kV

<sup>[1]</sup> Stresses above one or more of the limiting values may cause permanent damage to the device.

#### 9. Characteristics

#### 9.1 Electrical characteristics

**Table 22. Characteristics** 

In accordance with the Absolute Maximum Rating System (IEC 60134).[1][2][3]

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
f <sub>i</sub>	input frequency			-	13.56	-	MHz
C <sub>i</sub>	input capacitance	50 pF version	[4]	44	50	56	pF
Vo	output voltage	FD pin		1.2	1.8	2.0	V
<b>EEPROM</b>	characteristics						
t <sub>cy(W)</sub>	write cycle time			-	4.1	-	ms
t <sub>ret</sub>	retention time	T <sub>amb</sub> = 22 °C		10	-	-	year
$N_{\text{endu(W)}}$	write endurance	T <sub>amb</sub> = 22 °C		10000	-	-	cycle

<sup>[1]</sup> Stresses above one or more of the limiting values may cause permanent damage to the device.

<sup>[2]</sup> Exposure to limiting values for extended periods may affect device reliability.

<sup>[3]</sup> MIL Standard 883-C method 3015; Human body model: C = 100 pF, R = 1.5 k $\Omega$ .

<sup>[4]</sup> For safe operation the suggested maximum static current from the VDD pin shall not be above the maximum load current (refer to Application note Ref. 11 "AN11141 How to use the FD pin").

<sup>[2]</sup> These are stress ratings only. Operation of the device at these or any other conditions above those given in the Characteristics section of the specification is not implied.

<sup>[3]</sup> Exposure to limiting values for extended periods may affect device reliability.

<sup>[4]</sup> LCR meter HP 4285,  $T_{amb}$  = 22 °C, Cp-D,  $f_i$  = 13.56 MHz, 2Veff.

#### NFC Forum compliant IC with user memory and field detection

### 10. Package outline

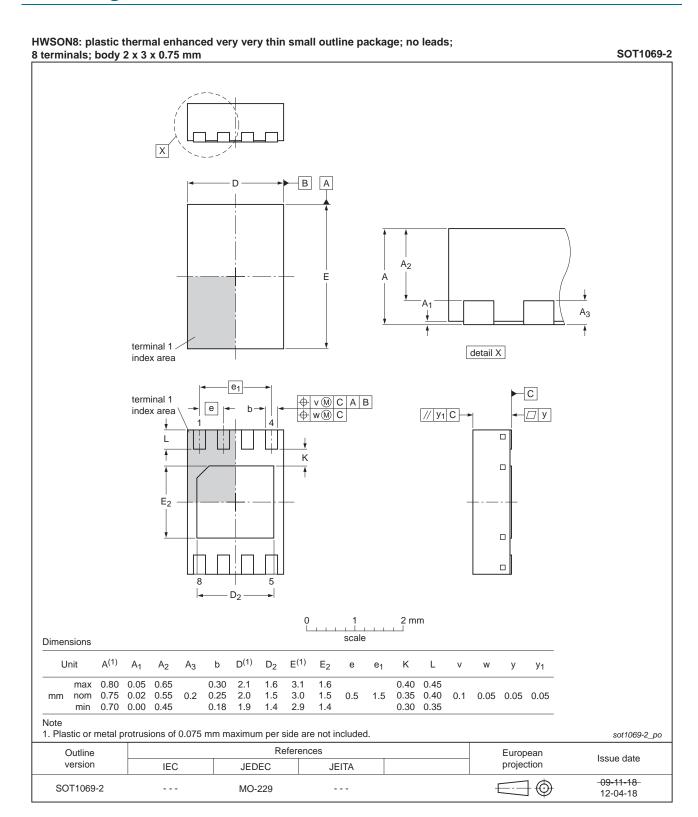


Fig 20. Package outline SOT1069-2

NTAG203F

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2013. All rights reserved.

#### NFC Forum compliant IC with user memory and field detection

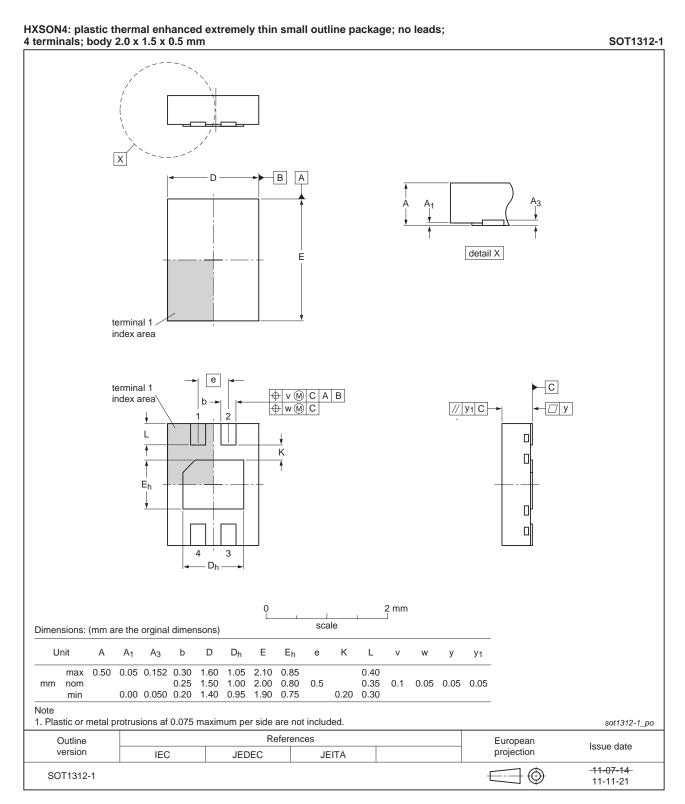


Fig 21. Package outline SOT1312AB2 (HXSON4)

### NFC Forum compliant IC with user memory and field detection

### 11. Abbreviations

Table 23. Abbreviations

Acronym	Description
ACK	positive ACKnowledge
ATQA	Answer To reQuest, type A
BCC	Block Check Characters byte
CBC	Cipher-Block Chaining
CC	Capability Container
CRC	Cyclic Redundancy Check
СТ	Cascade Tag, Type A
EEPROM	Electrically Erasable Programmable Read-Only Memory
IV	Initial Value
MSB	Most Significant Bit
NAK	Negative AcKnowledge
LSB	Least Significant Bit
OTP	One Time Programmable
Passive ACK	Implicit acknowledge without PICC answer
PCD	Proximity Coupling Device
PICC	Proximity Integrated Circuit Card
POR	Power On Reset
REQA	ReQuest Answer, type A
RF	Radio Frequency
SAK	Select AcKnowledge, type A
UID	Unique IDentifier
WUPA	Wake-UP command, type A

#### NFC Forum compliant IC with user memory and field detection

#### 12. References

- [1] ISO/IEC 14443-2 (2001) and ISO/IEC 14443-2 (2001)
- [2] AN10833 MIFARE Type Identification Procedure Application note, BU-ID Doc. No.: 0184\*\*2
- [3] AN10834 MIFARE ISO/IEC 14443 PICC Selection Application note, BU-ID Doc. No.: 1308\*\*2
- [4] AN Ultralight Features and Hints Application note, BU-ID Doc. No.: 0731\*\*2
- [5] AN1303 Ultralight as Type 2 Tag Application note, BU-ID Doc. No.: 1303\*\*2
- [6] AN11276 NTAG Antenna Design Guide Application note , BU-ID Doc. No.: 2421\*\*2
- [7] MF0ICU1 Functional specification MIFARE Ultralight Product data sheet, BU-ID Doc. No. 0286\*\*2
- [8] NFC Forum Tag 2 Type Operation, Technical Specification NFC Forum, 31.05.2011, Version 1.1
- [9] NFC Data Exchange Format (NDEF), Technical Specification NFC Forum, 24.07.2006, Version 1.0
- [10] AN10365 Surface mount reflow soldering Application note , NXP Semiconductors
- [11] AN11141 How to use the FD pin Application note, BU-ID Doc. No.: 2214\*2
- [12] NFC Digital Protocol, Technical Specification NFC Forum, 17.11.2010, Version 1.0

<sup>2. \*\* ...</sup> document version number

#### NFC Forum compliant IC with user memory and field detection

### 13. Revision history

#### Table 24. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
NTAG203F v.3.3	20130212	Product data sheet	-	NTAG203F v.3.2			
Modifications:	<ul> <li>Drawings upda</li> </ul>	ate					
NTAG203F v.3.2	20130123	Product data sheet	-	NTAG203F v.3.1			
Modifications:	<ul> <li>Correction of F</li> </ul>	HXSON4 Marking					
NTAG203F v.3.1	20121113	Product data sheet	-	NTAG203F v.3.0			
Modifications:	<ul> <li>Editorial chang</li> </ul>	gings and corrections					
	<ul> <li>New package</li> </ul>	New package "HXSON4" added					
	<ul> <li>Data retention</li> </ul>	updated to 10 years					
	<ul> <li>Section 14.4 "I</li> </ul>	<u>icenses"</u> : updated					
	<ul> <li>Security status</li> </ul>	changed into "COMPANY PL	JBLIC"				
NTAG203F v.3.0	20111215	Product data sheet	-	-			
·							

### NFC Forum compliant IC with user memory and field detection

### 14. Legal information

#### 14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 14.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 14.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

NTAG203F

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2013. All rights reserved.

### NFC Forum compliant IC with user memory and field detection

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any

liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

#### 14.4 Licenses

#### Purchase of NXP ICs with NFC technology

Purchase of an NXP Semiconductors IC that complies with one of the Near Field Communication (NFC) standards ISO/IEC 18092 and ISO/IEC 21481 does not convey an implied license under any patent right infringed by implementation of any of those standards.

#### 14.5 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

MIFARE — is a trademark of NXP B.V.

MIFARE Ultralight — is a trademark of NXP B.V.

#### 15. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

#### NFC Forum compliant IC with user memory and field detection

### 16. Tables

Table 1.	Short naming convention (for easier product		level 1	17
	identification)2	Table 14.	ANTICOLLISION and SELECT of cascade	
Table 2.	Ordering information3		level 2	18
	Pin description of the HWSON8 package 4	Table 15.	READ	19
Table 4.	Pin description of the HXSON4 package 5		HALT	
Table 5.	Marking HWSON8 (NTAG203F)5	Table 17.	WRITE	20
Table 6.	Marking HXSON4 (NTAG203F) 5	Table 18.	COMPATIBILITY WRITE	21
Table 7.	Memory organization	Table 19.	COMPATIBILITY_WRITE timing	21
Table 8.	Lock bytes	Table 20.	Summary of relevant data for device	
Table 9.	Initial memory organization14		identification	22
Table 10.	ACK and NAK values	Table 21.	Limiting values	23
Table 11.	REQA16	Table 22.	Characteristics	23
	WUPA	Table 23.	Abbreviations	26
Table 13.	ANTICOLLISION and SELECT of cascade	Table 24.	Revision history	28

### 17. Figures

Fig 1.	NFC Tag interacting with NFC enabled device .	1
Fig 2.	Block diagram	
Fig 3.	Pin configuration for SOT1069-2 (HWSON8)	4
Fig 4.	Pin configuration for SOT1312AB2 (HXSON4) .	5
Fig 5.	Communication principle state diagram - 4-byte	;
	16-byte	7
Fig 6.	UID/serial number	.10
Fig 7.	Lock bytes 0 and 1	.12
Fig 8.	Lock bytes 2 and 3	.12
Fig 9.	CC bytes	.13
Fig 10.	REQA	.16
Fig 11.	WUPA	.16
Fig 12.	ANTICOLLISION of cascade level 1	.17
Fig 13.	SELECT of cascade level 1	.17
Fig 14.	ANTICOLLISION of cascade level 2	.18
Fig 15.	SELECT of cascade level 2	.18
Fig 16.	READ	.19
Fig 17.	HALT	.19
Fig 18.	WRITE	.20
Fig 19.	COMPATIBILITY WRITE	.21
Fig 20.	Package outline SOT1069-2	.24
Fig 21.	Package outline SOT1312AB2 (HXSON4)	.25

NTAG203F **NXP Semiconductors** NFC Forum compliant IC with user memory and field detection

### 18. Contents

1	General description
1.1	Contactless energy and data transfer 1
1.2	Naming conventions 2
2	Features and benefits 2
2.1	RF Interface (ISO/IEC 14443A) 2
2.2	EEPROM 2
2.3	NFC Forum Tag 2 Type compliance 2
2.4	Field detection 2
2.5	Security
2.6	Cascaded UID
2.7	Anticollision
3	Ordering information 3
4	Block diagram 4
5	Pinning information 4
6	Marking 5
6.1	Marking HWSON8 5
6.2	Marking HXSON45
7	Functional description 6
7.1	Block description 6
7.2	State diagram and logical states description 7
7.2.1	Idle state
7.2.2	Ready1 state 8
7.2.3	Ready2 state 8
7.2.4	Active state
7.2.5	Halt state9
7.3	Data integrity9
7.4 7.5	RF interface
7.5 7.5.1	Memory organization
7.5.1	Lock bytes
7.5.2	Capability Container (CC)
7.5.4	Data pages
7.5.5	Initial memory configuration
7.6	Counter
7.7	Tag response to a command from NFC device 15
7.8	NFC Forum Device timings requirements 15
7.9	Command set
7.9.1	REQA
7.9.2	WUPA
7.9.3	ANTICOLLISION and SELECT of cascade level 1
7.9.4	ANTICOLLISION and SELECT of cascade
	level 2
7.9.5	READ
7.9.6	HALT
7.9.7	WRITE 20
7.9.8	COMPATIBILITY WRITE 21

7.10	Summary of relevant data for device	
	identification	22
8	Limiting values	23
9	Characteristics	23
9.1	Electrical characteristics	23
10	Package outline	24
11	Abbreviations	26
12	References	27
13	Revision history	28
14	Legal information	29
14.1	Data sheet status	29
14.2	Definitions	29
14.3	Disclaimers	29
14.4	Licenses	30
14.5	Trademarks	30
15	Contact information	30
16	Tables	31
17	Figures	31
18		32

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2013.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com